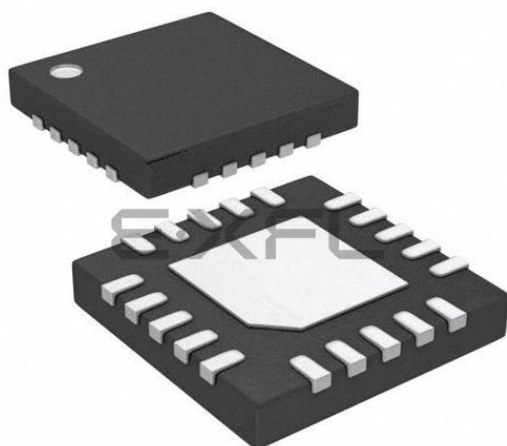




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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	17
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-UFQFN Exposed Pad
Supplier Device Package	20-UQFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1828-i-gz

PIC16(L)F1824/8

TABLE 1: 14-PIN AND 16-PIN ALLOCATION TABLE (PIC16(L)F1824)

I/O	14-Pin PDIP/SSOP	16-Pin QFN/QFN	A/D	Reference	Cap Sense	Comparator	SR Latch	Timers	ECCP	EUSART	MSSP	Interrupt	Modulator	Pull-up	Basic
RA0	13	12	AN0	VREF-DACOUT	CPS0	C1IN+	—	—	—	TX ⁽¹⁾ CK ⁽¹⁾	—	IOC	—	Y	ICSPDAT ICDDAT
RA1	12	11	AN1	VREF+	CPS1	C12IN0-	SRI	—	—	RX ⁽¹⁾ DT ⁽¹⁾	—	IOC	—	Y	ICSPCLK ICDCLK
RA2	11	10	AN2	—	CPS2	C1OUT	SRQ	T0CKI	CCP3 FLT0	—	—	INT/ IOC	—	Y	—
RA3	4	3	—	—	—	—	—	T1G ⁽¹⁾	—	—	SS ⁽¹⁾	IOC	—	Y	MCLR VPP
RA4	3	2	AN3	—	CPS3	—	—	T1G ⁽¹⁾ T1OSO	P2B ⁽¹⁾	—	SDO ⁽¹⁾	IOC	—	Y	OSC2 CLKOUT CLKR
RA5	2	1	—	—	—	—	—	T1CKI T1OSI	CCP2 P2A ⁽¹⁾	—	—	IOC	—	Y	OSC1 CLKIN
RC0	10	9	AN4	—	CPS4	C2IN+	—	—	P1D ⁽¹⁾	—	SCL SCK	—	—	Y	—
RC1	9	8	AN5	—	CPS5	C12IN1-	—	—	CCP4 P1C ⁽¹⁾	—	SDA SDI	—	—	Y	—
RC2	8	7	AN6	—	CPS6	C12IN2-	—	—	P1D ⁽¹⁾ P2B ⁽¹⁾	—	SDO ⁽¹⁾	—	MDCIN1	Y	—
RC3	7	6	AN7	—	CPS7	C12IN3-	—	—	CCP2 ⁽¹⁾ P1C ⁽¹⁾ P2A ⁽¹⁾	—	SS ⁽¹⁾	—	MDMIN	Y	—
RC4	6	5	—	—	—	C2OUT	SRNQ	—	P1B	TX ⁽¹⁾ CK ⁽¹⁾	—	—	MDOUT	Y	—
RC5	5	4	—	—	—	—	—	—	CCP1 P1A	RX ⁽¹⁾ DT ⁽¹⁾	—	—	MDCIN2	Y	—
VDD	1	16	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	14	13	—	—	—	—	—	—	—	—	—	—	—	—	VSS

Note 1: Pin function is selectable via the APFCON0 or APFCON1 registers.

PIC16(L)F1824/8

REGISTER 5-3: OSCTUNE: OSCILLATOR TUNING REGISTER

U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	TUN<5:0>					
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
u = Bit is unchanged x = Bit is unknown -n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set '0' = Bit is cleared

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **TUN<4:0>:** Frequency Tuning bits

011111 = Maximum frequency

011110 =

•

•

•

000001 =

000000 = Oscillator module is running at the factory-calibrated frequency.

111111 =

•

•

•

100000 = Minimum frequency

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	SPLLEN	IRCF<3:0>				—	SCS<1:0>		68
OSCSTAT	T1OSCR	PLLRL	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS	69
OSCTUNE	—	—	TUN<5:0>						70
PIE2	OSFIE	C2IE	C1IE	EEIE	BCL1IE	—	—	CCP2IE	91
PIR2	OSFIF	C2IF	C1IF	EEIF	BCL1IF	—	—	CCP2IF	94
T1CON	TMR1CS<1:0>		T1CKPS<1:0>		T1OSCEN	T1SYNC	—	TMR1ON	186

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 5-3: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	FCMEN	IESO	CLKOUTEN	BOREN<1:0>		CPD	48
	7:0	CP	MCLRRE	PWRTE	WDTE<1:0>		FOSC<2:0>			

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

PIC16(L)F1824/8

7.10 Determining the Cause of a Reset

Upon any Reset, multiple bits in the STATUS and PCON register are updated to indicate the cause of the Reset. Table 7-3 and Table 7-4 show the Reset conditions of these registers.

TABLE 7-3: RESET STATUS BITS AND THEIR SIGNIFICANCE

STKOVF	STKUNF	RMCLR	RI	POR	BOR	TO	PD	Condition
0	0	1	1	0	x	1	1	Power-on Reset
0	0	1	1	0	x	0	x	Illegal, $\overline{TO}$ is set on $\overline{POR}$
0	0	1	1	0	x	x	0	Illegal, $\overline{PD}$ is set on $\overline{POR}$
0	0	1	1	u	0	1	1	Brown-out Reset
u	u	u	u	u	u	0	u	WDT Reset
u	u	u	u	u	u	0	0	WDT Wake-up from Sleep
u	u	u	u	u	u	1	0	Interrupt Wake-up from Sleep
u	u	0	u	u	u	u	u	$\overline{MCLR}$ Reset during normal operation
u	u	0	u	u	u	1	0	$\overline{MCLR}$ Reset during Sleep
u	u	u	0	u	u	u	u	RESET Instruction Executed
1	u	u	u	u	u	u	u	Stack Overflow Reset (STVREN = 1)
u	1	u	u	u	u	u	u	Stack Underflow Reset (STVREN = 1)

TABLE 7-4: RESET CONDITION FOR SPECIAL REGISTERS⁽²⁾

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	0000h	---1 1000	00-- 110x
$\overline{MCLR}$ Reset during normal operation	0000h	---u uuuu	uu-- 0uuu
$\overline{MCLR}$ Reset during Sleep	0000h	---1 0uuu	uu-- 0uuu
WDT Reset	0000h	---0 uuuu	uu-- uuuu
WDT Wake-up from Sleep	PC + 1	---0 0uuu	uu-- uuuu
Brown-out Reset	0000h	---1 1uuu	00-- 11u0
Interrupt Wake-up from Sleep	PC + 1 ⁽¹⁾	---1 0uuu	uu-- uuuu
RESET Instruction Executed	0000h	---u uuuu	uu-- u0uu
Stack Overflow Reset (STVREN = 1)	0000h	---u uuuu	1u-- uuuu
Stack Underflow Reset (STVREN = 1)	0000h	---u uuuu	u1-- uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and Global Interrupt Enable bit (GIE) is set, the return address is pushed on the stack and PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

2: If a Status bit is not implemented, that bit will be read as '0'.

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8.5.6 PIR2 REGISTER

The PIR2 register contains the interrupt flag bits, as shown in Register 8-6.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 8-6: PIR2: PERIPHERAL INTERRUPT REQUEST REGISTER 2

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0
OSFIF	C2IF	C1IF	EEIF	BCL1IF	—	—	CCP2IF
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

- bit 7 **OSFIF:** Oscillator Fail Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending
- bit 6 **C2IF:** Comparator C2 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending
- bit 5 **C1IF:** Comparator C1 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending
- bit 4 **EEIF:** EEPROM Write Completion Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending
- bit 3 **BCL1IF:** MSSP Bus Collision Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending
- bit 2-1 **Unimplemented:** Read as '0'
- bit 0 **CCP2IF:** CCP2 Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

16.2 ADC Operation

16.2.1 STARTING A CONVERSION

To enable the ADC module, the ADON bit of the ADCON0 register must be set to a '1'. Setting the GO/DONE bit of the ADCON0 register to a '1' will start the Analog-to-Digital conversion.

Note: The GO/DONE bit should not be set in the same instruction that turns on the ADC. Refer to **Section 16.2.6 “A/D Conversion Procedure”**.

16.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF Interrupt Flag bit
- Update the ADRESH and ADRESL registers with new conversion result

16.2.3 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/DONE bit can be cleared in software. The ADRESH and ADRESL registers will be updated with the partially complete Analog-to-Digital conversion sample. Incomplete bits will match the last bit converted.

Note: A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

16.2.4 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the FRC option. When the FRC clock source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than FRC, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

16.2.5 SPECIAL EVENT TRIGGER

The Special Event Trigger of the CCPx/ECCPx module allows periodic ADC measurements without software intervention. When this trigger occurs, the GO/DONE bit is set by hardware and the Timer1 counter resets to zero.

TABLE 16-2: SPECIAL EVENT TRIGGER

Device	CCPx/ECCPx
PIC16(L)F1824/8	CCP4

Using the Special Event Trigger does not assure proper ADC timing. It is the user's responsibility to ensure that the ADC timing requirements are met.

Refer to **Section 24.0 “Capture/Compare/PWM Modules”** for more information.

19.0 COMPARATOR MODULE

Comparators are used to interface analog circuits to a digital circuit by comparing two analog voltages and providing a digital indication of their relative magnitudes. Comparators are very useful mixed signal building blocks because they provide analog functionality independent of program execution. The analog comparator module includes the following features:

- Independent comparator control
- Programmable input selection
- Comparator output is available internally/externally
- Programmable output polarity
- Interrupt-on-change
- Wake-up from Sleep
- Programmable Speed/Power optimization
- PWM shutdown
- Programmable and Fixed Voltage Reference

19.1 Comparator Overview

A single comparator is shown in Figure 19-1 along with the relationship between the analog input levels and the digital output. When the analog voltage at V_{IN+} is less than the analog voltage at V_{IN-} , the output of the comparator is a digital low level. When the analog voltage at V_{IN+} is greater than the analog voltage at V_{IN-} , the output of the comparator is a digital high level.

FIGURE 19-1: SINGLE COMPARATOR

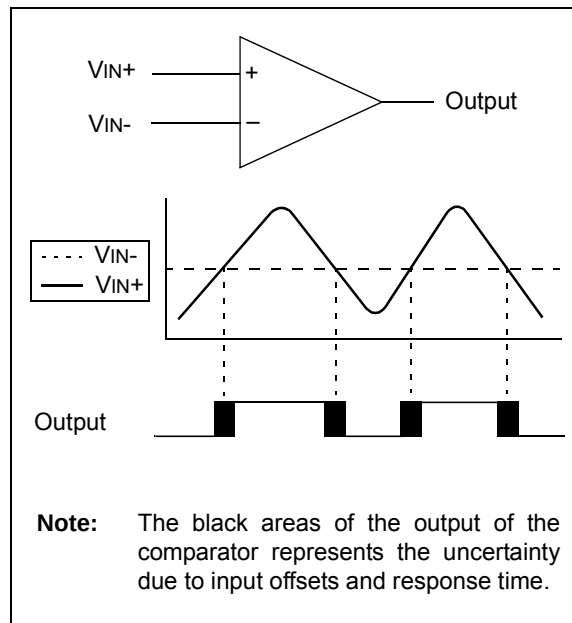
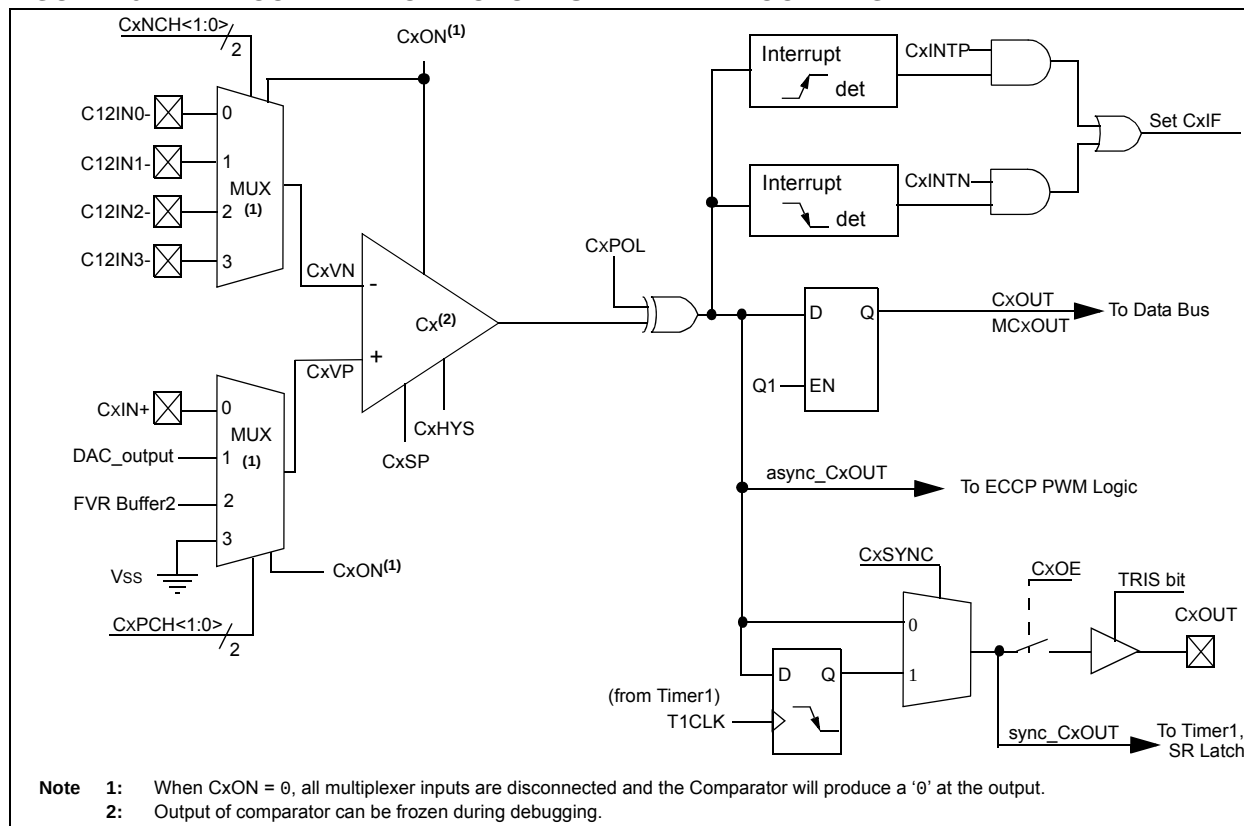


FIGURE 19-2: COMPARATOR MODULE SIMPLIFIED BLOCK DIAGRAM



REGISTER 19-1: CMxCON0: COMPARATOR Cx CONTROL REGISTER 0

R/W-0/0	R-0/0	R/W-0/0	R/W-0/0	U-0	R/W-1/1	R/W-0/0	R/W-0/0
CxON	CxOUT	CxOE	CxPOL	—	CxSP	CxHYS	CxSYNC
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7	CxON: Comparator Enable bit 1 = Comparator is enabled 0 = Comparator is disabled and consumes no active power
bit 6	CxOUT: Comparator Output bit <u>If CxPOL = 1 (inverted polarity):</u> 1 = CxVP < CxVN 0 = CxVP > CxVN <u>If CxPOL = 0 (non-inverted polarity):</u> 1 = CxVP > CxVN 0 = CxVP < CxVN
bit 5	CxOE: Comparator Output Enable bit 1 = CxOUT is present on the CxOUT pin. Requires that the associated TRIS bit be cleared to actually drive the pin. Not affected by CxON. 0 = CxOUT is internal only
bit 4	CxPOL: Comparator Output Polarity Select bit 1 = Comparator output is inverted 0 = Comparator output is not inverted
bit 3	Unimplemented: Read as '0'
bit 2	CxSP: Comparator Speed/Power Select bit 1 = Comparator operates in normal power, higher speed mode 0 = Comparator operates in low-power, low-speed mode
bit 1	CxHYS: Comparator Hysteresis Enable bit 1 = Comparator hysteresis enabled 0 = Comparator hysteresis disabled
bit 0	CxSYNC: Comparator Output Synchronous Mode bit 1 = Comparator output to Timer1 and I/O pin is synchronous to changes on Timer1 clock source. Output updated on the falling edge of Timer1 clock source. 0 = Comparator output to Timer1 and I/O pin is asynchronous.

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24.0 CAPTURE/COMPARE/PWM MODULES

The Capture/Compare/PWM module is a peripheral which allows the user to time and control different events, and to generate Pulse-Width Modulation (PWM) signals. In Capture mode, the peripheral allows the timing of the duration of an event. The Compare mode allows the user to trigger an external event when a predetermined amount of time has expired. The PWM mode can generate Pulse-Width Modulated signals of varying frequency and duty cycle.

This family of devices contains two Enhanced Capture/Compare/PWM modules (ECCP1 and ECCP2) and two standard Capture/Compare/PWM modules (CCP3 and CCP4).

The capture and compare functions are identical for all four CCP modules (ECCP1, ECCP2, CCP3, and CCP4). The only differences between CCP modules are in the Pulse-Width Modulation (PWM) function. The standard PWM function is identical in modules, CCP3 and CCP4. In CCP modules ECCP1 and ECCP2, the Enhanced PWM function has slight variations from one another. Full-Bridge ECCP modules have four available I/O pins while Half-Bridge ECCP modules only have two available I/O pins. See Table 24-1 for more information.

Note 1: In devices with more than one CCP module, it is very important to pay close attention to the register names used. A number placed after the module acronym is used to distinguish between separate modules. For example, the CCP1CON and CCP2CON control the same operational aspects of two completely different CCP modules.

2: Throughout this section, generic references to a CCP module in any of its operating modes may be interpreted as being equally applicable to ECCP1, ECCP2, CCP3 and CCP4. Register names, module signals, I/O pins, and bit names may use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module, when required.

TABLE 24-1: PWM RESOURCES

Device Name	ECCP1	ECCP2	CCP3	CCP4
PIC16(L)F1824/8	Enhanced PWM Full-Bridge	Enhanced PWM Half-Bridge	Standard PWM	Standard PWM

25.2.3 SPI MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK line. The master determines when the slave (Processor 2, Figure 25-5) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSP1BUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSP1SR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSP1BUF register as if a normal received byte (interrupts and Status bits appropriately set).

The clock polarity is selected by appropriately programming the CKP bit of the SSP1CON1 register and the CKE bit of the SSP1STAT register. This then, would give waveforms for SPI communication as shown in Figure 25-6, Figure 25-9 and Figure 25-10, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- $F_{osc}/4$ (or T_{cy})
- $F_{osc}/16$ (or $4 * T_{cy}$)
- $F_{osc}/64$ (or $16 * T_{cy}$)
- Timer2 output/2
- $F_{osc}/(4 * (SSP1ADD + 1))$

Figure 25-6 shows the waveforms for Master mode.

When the CKE bit is set, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSP1BUF is loaded with the received data is shown.

FIGURE 25-6: SPI MODE WAVEFORM (MASTER MODE)

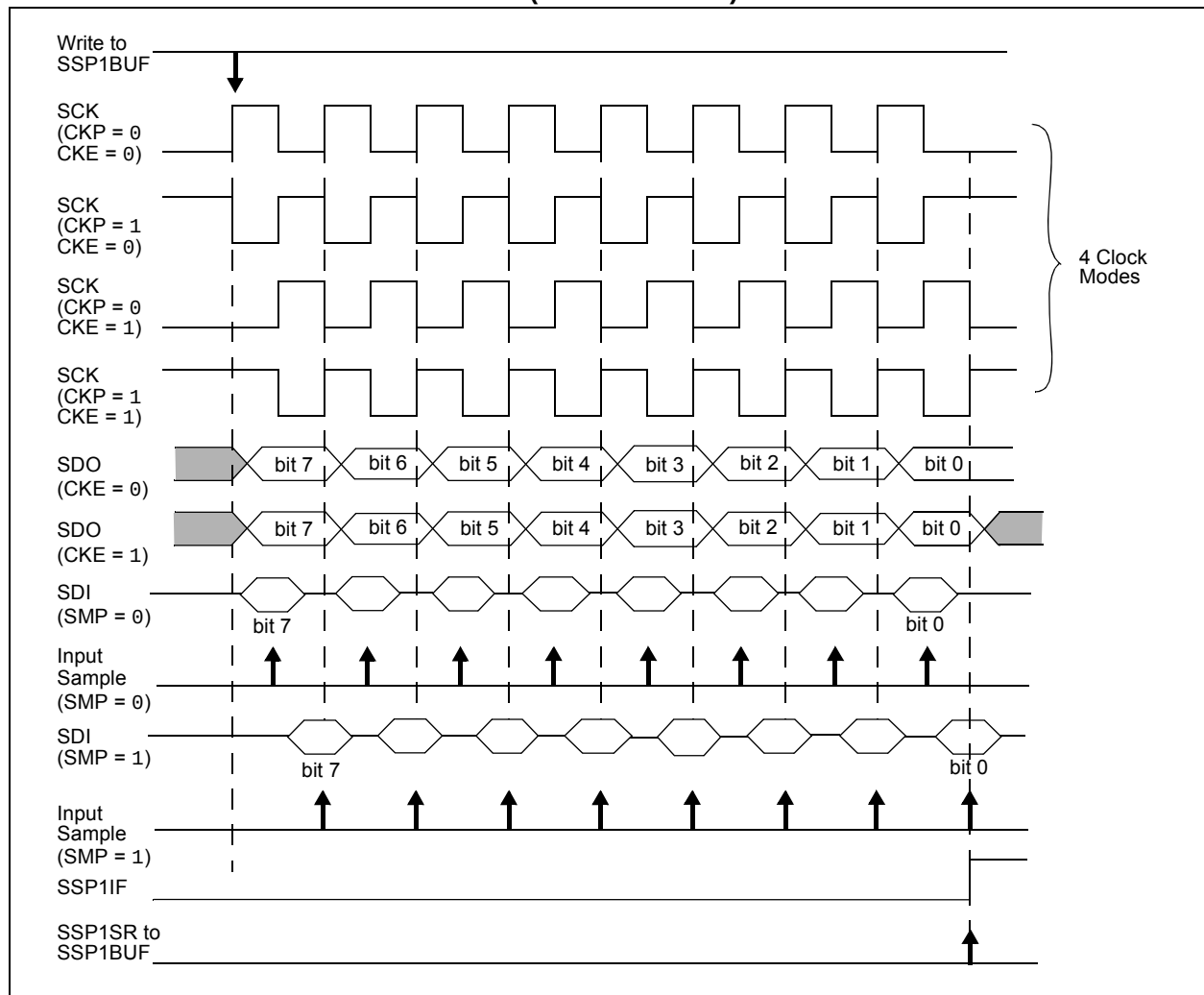


FIGURE 25-7: SPI DAISY-CHAIN CONNECTION

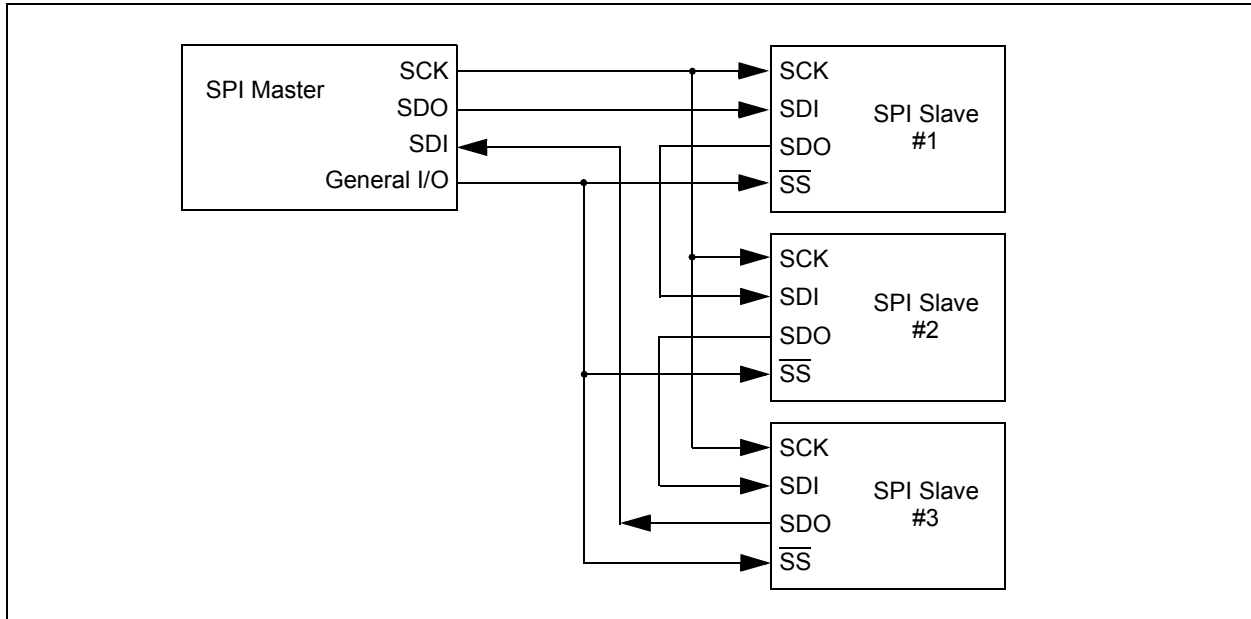
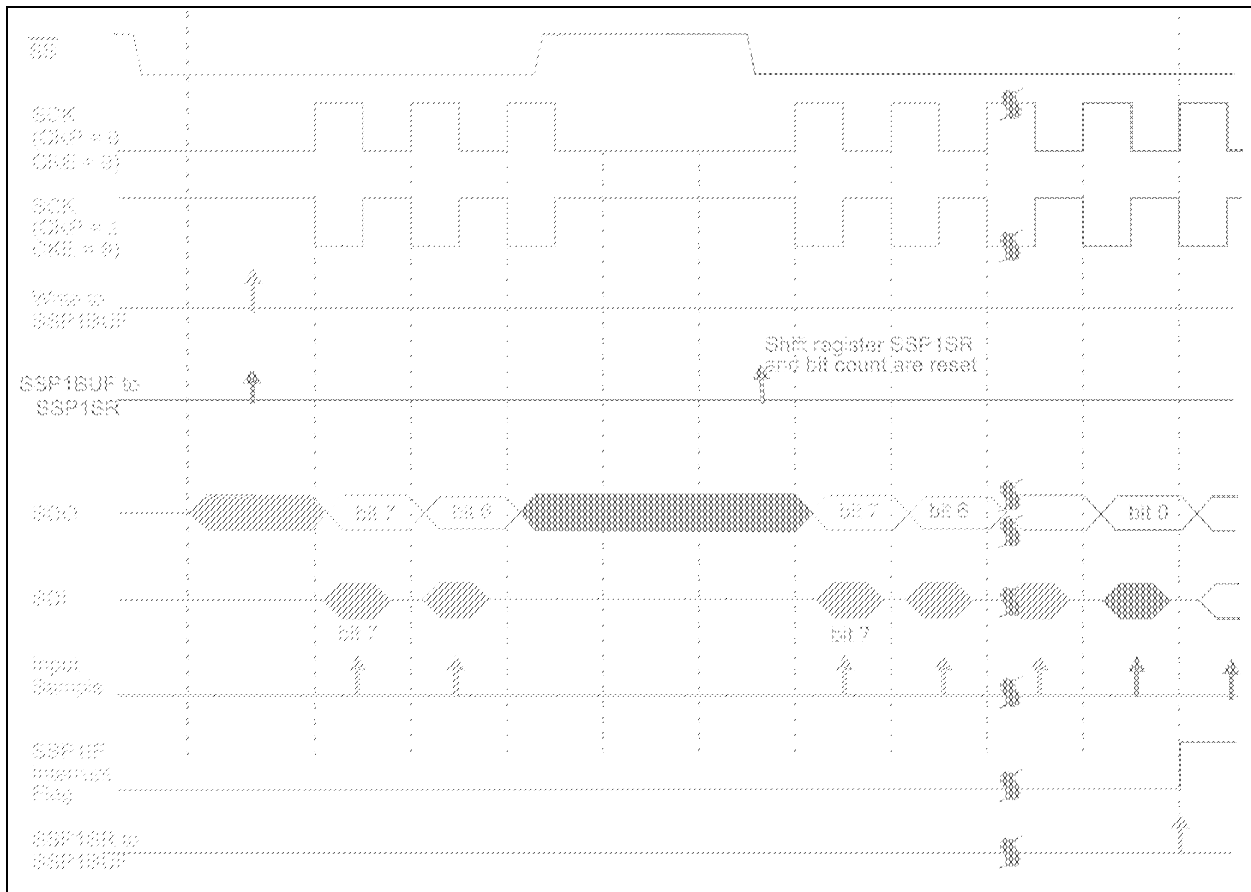


FIGURE 25-8: SLAVE SELECT SYNCHRONOUS WAVEFORM



PIC16(L)F1824/8

REGISTER 26-3: BAUDCON: BAUD RATE CONTROL REGISTER

R-0/0	R-1/1	U-0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0
ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7 **ABDOVF:** Auto-Baud Detect Overflow bit

Asynchronous mode:

1 = Auto-baud timer overflowed

0 = Auto-baud timer did not overflow

Synchronous mode:

Don't care

bit 6 **RCIDL:** Receive Idle Flag bit

Asynchronous mode:

1 = Receiver is Idle

0 = Start bit has been received and the receiver is receiving

Synchronous mode:

Don't care

bit 5 **Unimplemented:** Read as '0'

bit 4 **SCKP:** Synchronous Clock Polarity Select bit

Asynchronous mode:

1 = Transmit inverted data to the TX/CK pin

0 = Transmit non-inverted data to the TX/CK pin

Synchronous mode:

1 = Data is clocked on rising edge of the clock

0 = Data is clocked on falling edge of the clock

bit 3 **BRG16:** 16-bit Baud Rate Generator bit

1 = 16-bit Baud Rate Generator is used

0 = 8-bit Baud Rate Generator is used

bit 2 **Unimplemented:** Read as '0'

bit 1 **WUE:** Wake-up Enable bit

Asynchronous mode:

1 = Receiver is waiting for a falling edge. No character will be received, byte RCIF will be set. WUE will automatically clear after RCIF is set.

0 = Receiver is operating normally

Synchronous mode:

Don't care

bit 0 **ABDEN:** Auto-Baud Detect Enable bit

Asynchronous mode:

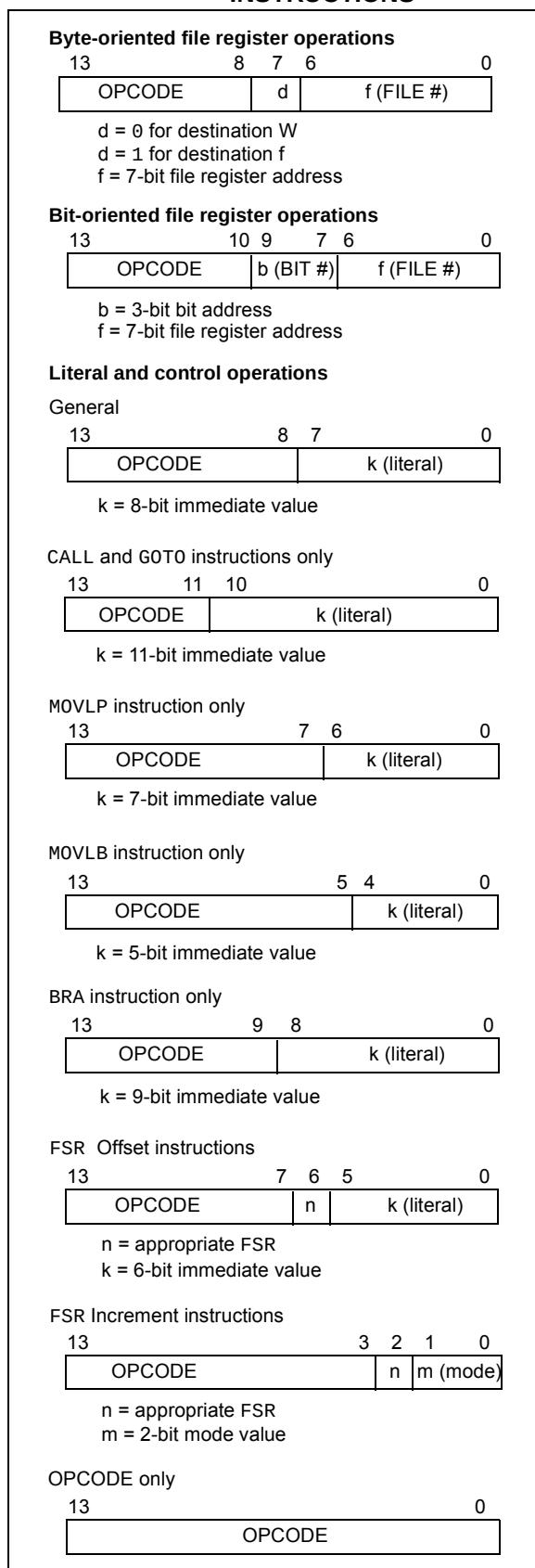
1 = Auto-Baud Detect mode is enabled (clears when auto-baud is complete)

0 = Auto-Baud Detect mode is disabled

Synchronous mode:

Don't care

FIGURE 29-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16(L)F1824/1828

CALL Call Subroutine

Syntax: [*label*] CALL *k*

Operands: $0 \leq k \leq 2047$

Operation: (PC)+1 → TOS,
k → PC<10:0>,
(PCLATH<4:3>) → PC<12:11>

Status Affected: None

Description: Call Subroutine. First, return address (PC + 1) is pushed onto the stack. The 11-bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a 2-cycle instruction.

CALLW Subroutine Call With W

Syntax: [*label*] CALLW

Operands: None

Operation: (PC) + 1 → TOS,
(W) → PC<7:0>,
(PCLATH<6:0>) → PC<14:8>

Status Affected: None

Description: Subroutine call with W. First, the return address (PC + 1) is pushed onto the return stack. Then, the contents of W is loaded into PC<7:0>, and the contents of PCLATH into PC<14:8>. CALLW is a 2-cycle instruction.

CLRF Clear f

Syntax: [*label*] CLRF *f*

Operands: $0 \leq f \leq 127$

Operation: 00h → (f)
1 → Z

Status Affected: Z

Description: The contents of register 'f' are cleared and the Z bit is set.

CLRW Clear W

Syntax: [*label*] CLRW

Operands: None

Operation: 00h → (W)
1 → Z

Status Affected: Z

Description: W register is cleared. Zero bit (Z) is set.

CLRWDTClear Watchdog Timer

Syntax: [*label*] CLRWDTClear Watchdog Timer

Operands: None

Operation: 00h → WDT
0 → WDT prescaler,
1 → $\overline{\text{TO}}$
1 → $\overline{\text{PD}}$

Status Affected: $\overline{\text{TO}}$, $\overline{\text{PD}}$

Description: CLRWDTClear Watchdog Timer. It also resets the prescaler of the WDT. Status bits $\overline{\text{TO}}$ and $\overline{\text{PD}}$ are set.

COMF Complement f

Syntax: [*label*] COMF *f*,*d*

Operands: $0 \leq f \leq 127$
d ∈ [0,1]

Operation: ($\bar{f}$) → (destination)

Status Affected: Z

Description: The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

DECF Decrement f

Syntax: [*label*] DECF *f*,*d*

Operands: $0 \leq f \leq 127$
d ∈ [0,1]

Operation: (f) - 1 → (destination)

Status Affected: Z

Description: Decrement register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

TABLE 30-4: CLKOUT AND I/O TIMING PARAMETERS

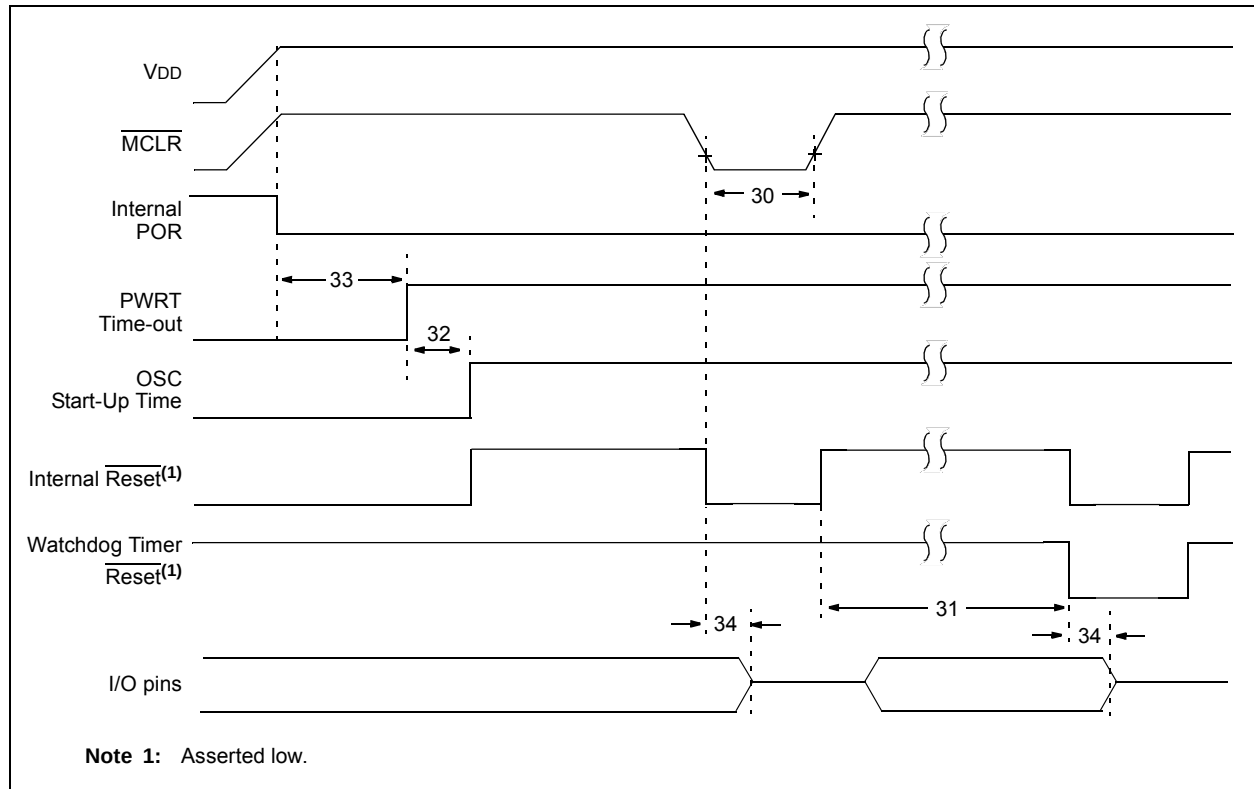
Standard Operating Conditions (unless otherwise stated) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
OS11	TosH2ckL	Fosc↑ to CLKOUT↓ ⁽¹⁾	—	—	70	ns	VDD = 3.0-5.0V
OS12	TosH2ckH	Fosc↑ to CLKOUT↑ ⁽¹⁾	—	—	72	ns	VDD = 3.0-5.0V
OS13	TckL2ioV	CLKOUT↓ to Port out valid ⁽¹⁾	—	—	20	ns	
OS14	TioV2ckH	Port input valid before CLKOUT↑ ⁽¹⁾	Tosc + 200 ns	—	—	ns	
OS15	TosH2ioV	Fosc↑ (Q1 cycle) to Port out valid	—	50	70*	ns	VDD = 3.0-5.0V
OS16	TosH2ioI	Fosc↑ (Q2 cycle) to Port input invalid (I/O in hold time)	50	—	—	ns	VDD = 3.0-5.0V
OS17	TioV2osH	Port input valid to Fosc↑ (Q2 cycle) (I/O in setup time)	20	—	—	ns	
OS18*	TioR	Port output rise time	—	40 15	72 32	ns	VDD = 1.8V VDD = 3.0-5.0V
OS19*	TioF	Port output fall time	—	28 15	55 30	ns	VDD = 1.8V VDD = 3.0-5.0V
OS20*	Tinp	INT pin input high or low time	25	—	—	ns	
OS21*	Tioc	Interrupt-on-change new input level time	25	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated.

Note 1: Measurements are taken in RC mode where CLKOUT output is 4 x Tosc.

FIGURE 30-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



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TABLE 30-6: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Standard Operating Conditions (unless otherwise stated) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$								
Param No.	Sym.	Characteristic		Min.	Typ†	Max.	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		Greater of: 20 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value (2, 4, ..., 256)
45*	Tt1H	T1CKI High Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
47*	Tt1P	T1CKI Input Period	Synchronous	Greater of: 30 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value (1, 2, 4, 8)
			Asynchronous	60	—	—	ns	
48	Ft1	Timer1 Oscillator Input Frequency Range (oscillator enabled by setting bit T1OSCEN)		32.4	32.768	33.1	kHz	
49*	TCKEZTMR1	Delay from External Clock Edge to Timer Increment		2 TOSC	—	7 TOSC	—	Timers in Sync mode

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 30-11: CAPTURE/COMPARE/PWM TIMINGS (CCP)

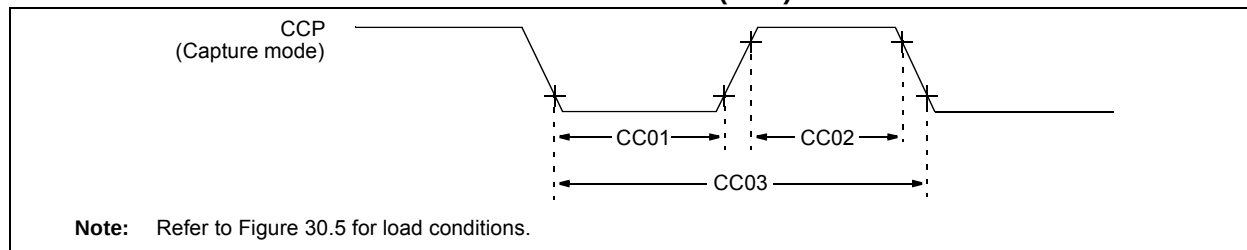


TABLE 30-7: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP)

Standard Operating Conditions (unless otherwise stated) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$								
Param No.	Sym.	Characteristic		Min.	Typ†	Max.	Units	Conditions
CC01*	TccL	CCP Input Low Time	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	20	—	—	ns	
CC02*	TccH	CCP Input High Time	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	20	—	—	ns	
CC03*	TccP	CCP Input Period		$\frac{3 T_{CY} + 40}{N}$	—	—	ns	N = prescale value

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 30-10: COMPARATOR SPECIFICATIONS

Operating Conditions (unless otherwise stated) V _{DD} = 3.0V, T _A = 25°C							
Param No.	Sym.	Characteristics	Min.	Typ.	Max.	Units	Comments
CM01	V _{IOFF} ⁽¹⁾	Input Offset Voltage	—	±7.5	±60	mV	High-Power mode, V _{ICM} = V _{DD} /2
CM02	V _{ICM}	Input Common Mode Voltage	0	—	V _{DD}	V	
CM03	CMRR	Common Mode Rejection Ratio	—	50	—	dB	
CM04A	T _{RESP} ⁽¹⁾	Response Time Rising Edge	—	400	800	ns	High-Power mode
CM04B		Response Time Falling Edge	—	200	400	ns	High-Power mode
CM04C		Response Time Rising Edge	—	1200	—	ns	Low-Power mode
CM04D		Response Time Falling Edge	—	550	—	ns	Low-Power mode
CM05	T _{MC2OV}	Comparator Mode Change to Output Valid*	—	—	10	µs	
CM06	CHYSTER	Comparator Hysteresis ⁽²⁾	—	45	—	mV	CxHYS = 1

* These parameters are characterized but not tested.

Note 1: High-Power mode only.

2: Comparator Hysteresis is available when the CxHYS bit of the CMxCON0 register is enabled.

TABLE 30-11: DIGITAL-TO-ANALOG CONVERTER (DAC) SPECIFICATIONS

Operating Conditions (unless otherwise stated) V _{DD} = 3.0V, T _A = 25°C							
Param No.	Sym.	Characteristics	Min.	Typ.	Max.	Units	Comments
DAC01*	CLSB	Step Size	—	V _{DD} /32	—	V	
DAC02*	CACC	Absolute Accuracy	—	—	± 1/2	LSb	
DAC03*	CR	Unit Resistor Value (R)	—	5K	—	Ω	
DAC04*	CST	Settling Time ⁽¹⁾	—	—	10	µs	

* These parameters are characterized but not tested.

Note 1: Settling time measured while DACR<4:0> transitions from '0000' to '1111'.

FIGURE 30-14: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

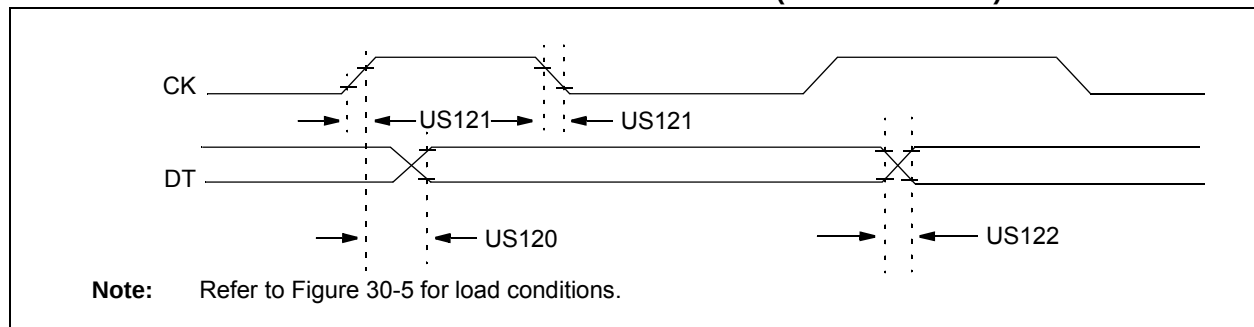


FIGURE 31-15: I_{DD} TYPICAL, HFINTOSC MODE, PIC16LF1824/8 ONLY

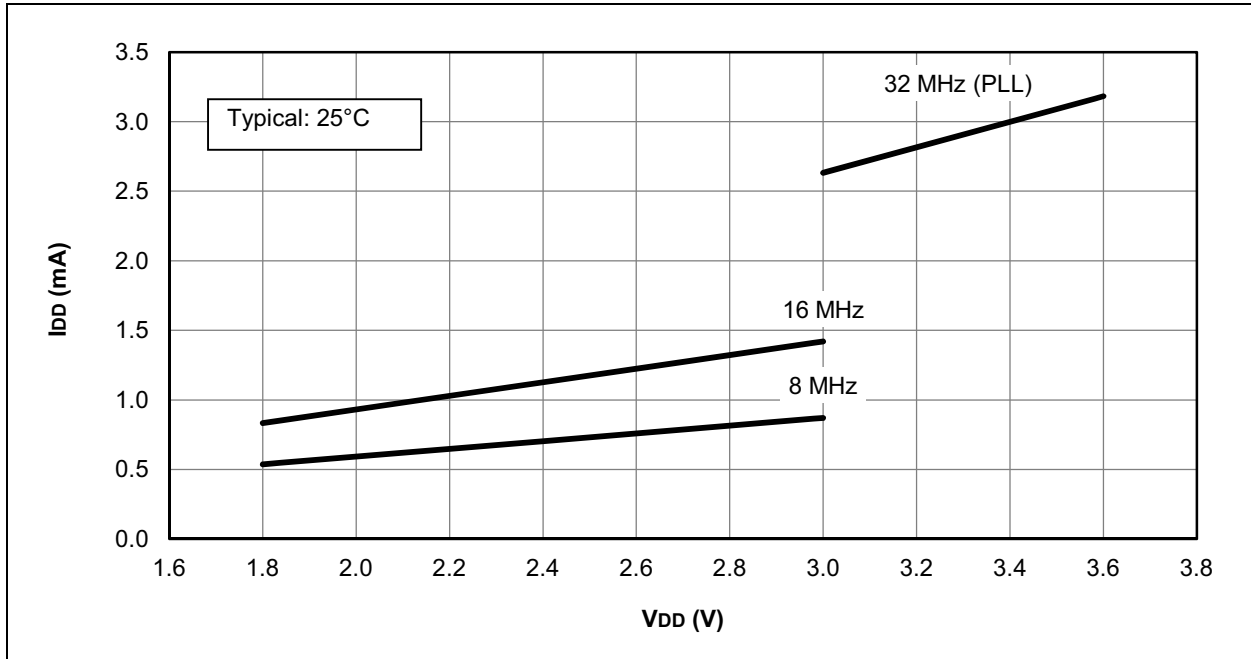
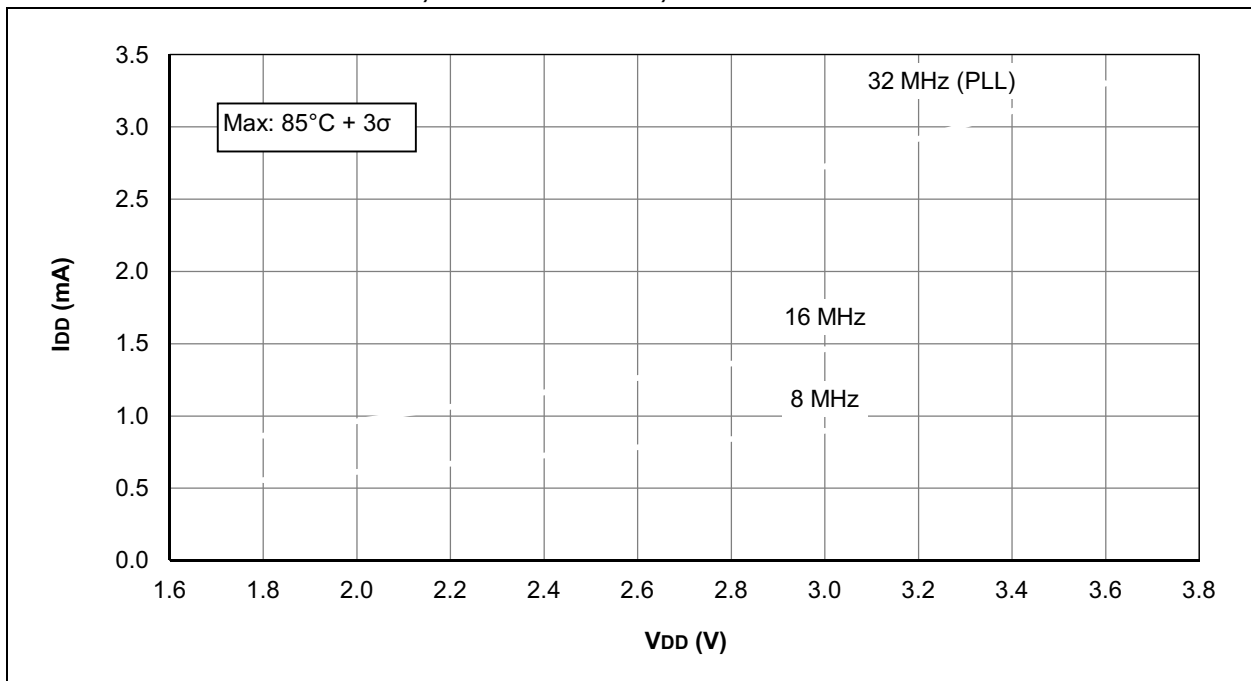


FIGURE 31-16: I_{DD} MAXIMUM, HFINTOSC MODE, PIC16LF1824/8 ONLY



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FIGURE 31-37: I_{PD}, COMPARATOR, LOW-POWER MODE (C_xSP = 0), PIC16LF1824/8 ONLY

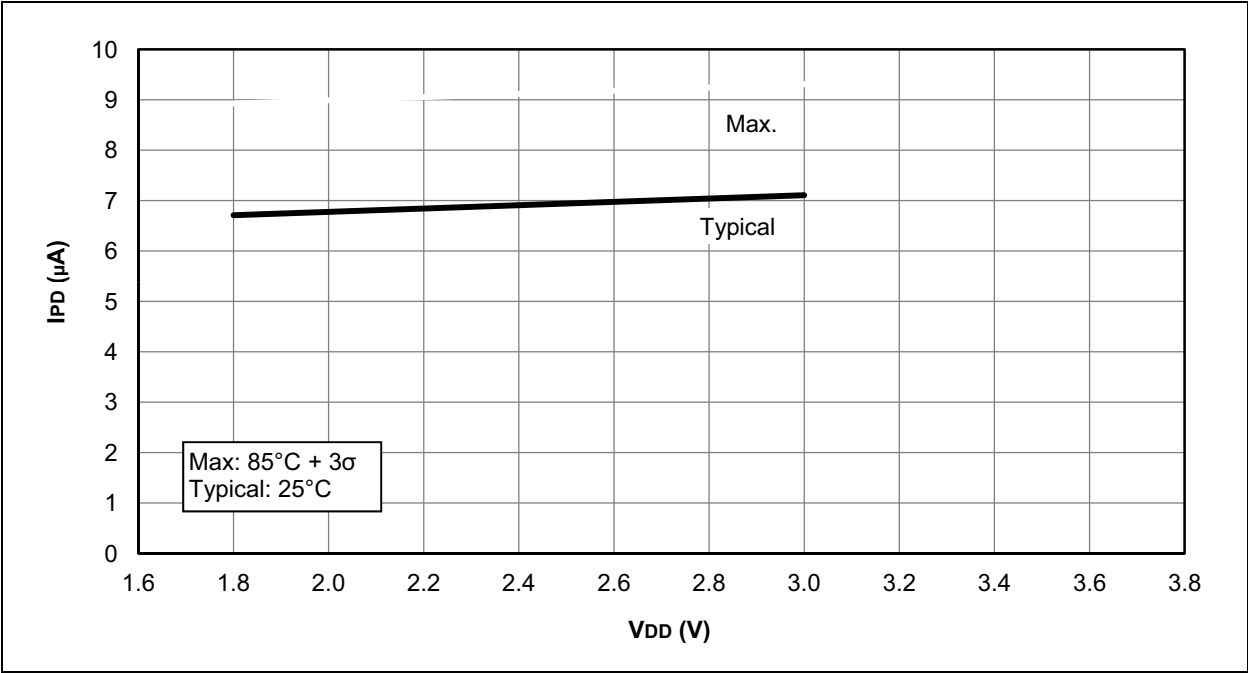


FIGURE 31-38: I_{PD}, COMPARATOR, LOW-POWER MODE (C_xSP = 0), PIC16F1824/8 ONLY

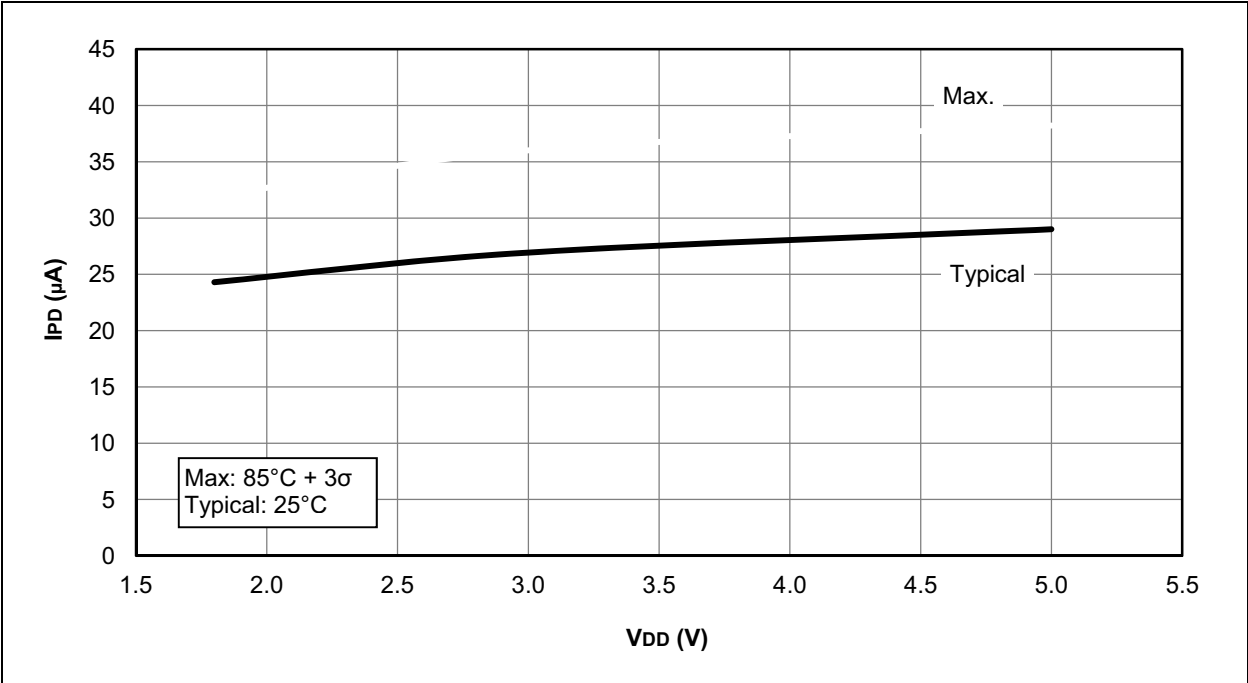


FIGURE 31-47: POR RELEASE VOLTAGE

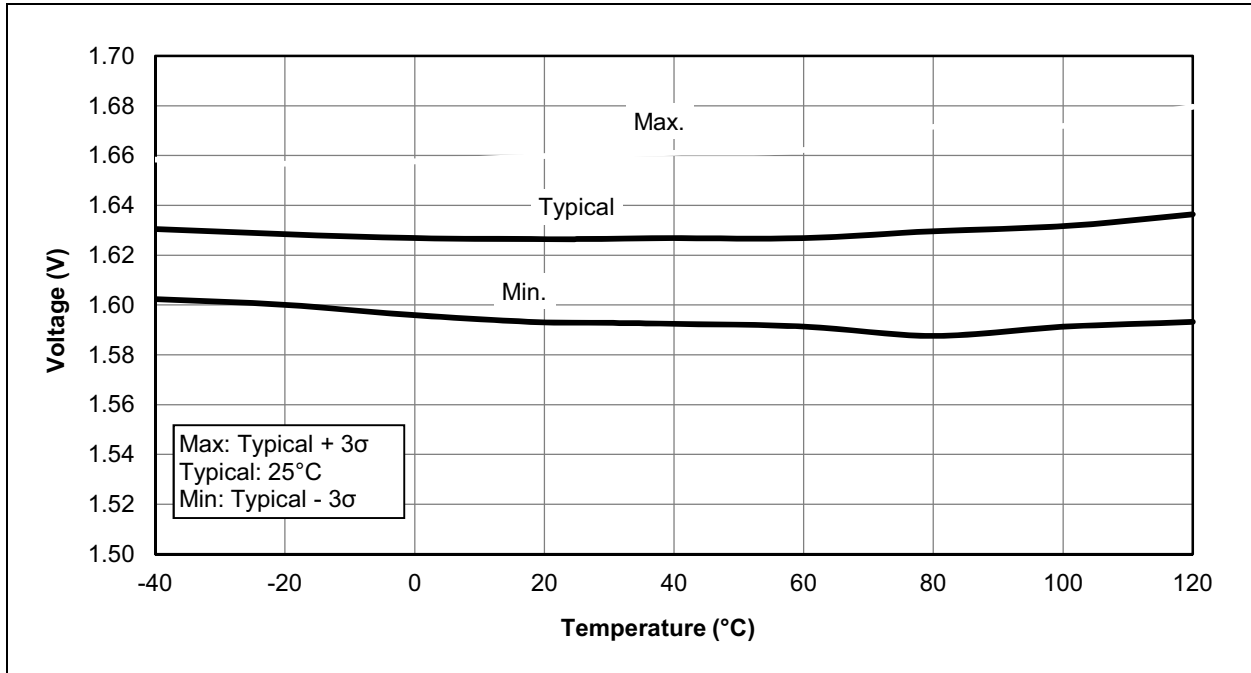


FIGURE 31-48: POR REARM VOLTAGE, PIC16F1824/8 ONLY

